## PRODUCT CHANGE NOTICE

<table>
<thead>
<tr>
<th>PART NUMBER(S):</th>
<th>PCN No.: 06-0130-16a</th>
</tr>
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<tbody>
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<td>Please see attachment.</td>
<td>DATE: June 23, 2006</td>
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### PART DESCRIPTION:

**Power Management and Interface Products – Change in Wafer Fabrication Site**

### LEVEL OF CHANGE:

- [X] Level I, Customer Approval.
- [ ] Level II, Customer Information.

### PRODUCT ATTRIBUTE AFFECTED:

- [ ] Material Change
- [ ] Design Change
- [X] Process Change
- [X] Other, Explain: Wafer Fabrication Site Transfer

### DESCRIPTION OF CHANGE:

Announcing transfer of certain Power Management and Interface Products from Hillview wafer fabrication facility to wafer foundry EPISIL. See attached Product List no. 16a.

### REASON FOR CHANGE:

Power Management and Interface products as listed are being transferred to external wafer foundry, due to cessation of operations of the Sipex Hillview Wafer Fabrication manufacturing site.

### FABRICATION PROCESS QUALIFICATION COMPLETED (DATE): November 25, 2006

### PRODUCT CHARACTERIZATION COMPLETED AND SAMPLES* AVAILABLE (DATE): December 2, 2006

* Samples representative of product from the Product Family being transferred.
# PRODUCT CHANGE NOTICE

**EARLIEST DATE OF PRODUCTION**

**SHIPMENTS:** January 31, 2007

**EFFECTIVITY CHANGE DATE OR DATE CODE:** Work week associated with earliest production shipment.

| [ ] STANDARD DISTRIBUTION | [X] CUSTOM DISTRIBUTION |

**PERSON TO CONTACT WITH QUESTIONS:**

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List 16a

SP331CT
SP331CT-L
SP331ET
SP331ET-L